[X] Original

[] Supplemental

Combined Declaration for Patent Application and Power of Attorney

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; and that I believe I am the original, firmly residence, post office address and citizenship are as stated below next to my name; and that I believe I am the original, firmly remove are listed below).

the subject matter which	th is claimed and for	sted below) or an origin or which a patent is soug	th on the invention e	entitled			,	
DIE FOR MOLE	ING DISC SU	BSTRATES	·					
the specification of wh	ich (check one)	•						
, () , ()	is attached hereto; was filed in the United States under 35 U.S.C. §111 on, as U.S. Appln. No*; or was/will be filed in the U.S. under 35 U.S.C. §371 by entry into the U.S. national stage of an international							
-	(PCT) application, PCT/; filed, entry requested on*; national stage application received U.S. Appln. No*; §371/§102(e) date* (* if known)							
and was amended on			(i	f applicable).				
_	(include dates of an	nendments under PCT Art.	19 and 34 if PCT)					
amendment referred to known by me to be ma I hereby claim foreig inventor's certificate.	above; and I acknoterial to patentabil n priority benefits or prior PCT appl	ntents of the above-ident nowledge the duty to dis ity as defined in 37 C.F. under 35 U.S.C. §§ 1 ication(s) designating a try such application hav	close to the Patent at R. §1.56. 19 and 365 of any country other than	nd Trademark (prior foreign the U.S., listed	Office (PTC application is below with	(s) for path the "Y	atent or	
2003-1	37247	Japan	15 May 2	003	[X]	[]		
(Number)		(Country)	(Day Month Year Fild)		YES []	NО []		
(Number)		(Country)	(Day Month Y	ear Fild)	YES	NO	•	
designating the U.S. I subject matter of each by the first paragraph	isted below, or un of the claims of the of 35 U.S.C. §112 ed between the fili	G.C. §120 of any prior der §119(e) of any prior his application is not die., I acknowledge the duting date of the prior app. (Day Month Year	r U.S. provisional ap- sclosed in such U.S. y to disclose to the F lication and the natio	or PCT applications listed or PCT application all informational filing date (Status: pate)	ed below, as ation in the ation as def of this appli ented, pendin	nd, insofa manner p ined in 37 ication:	ar as the provided	
				aban	idoned)			
(Applicat	ion No.)	(Day Month Year	Filed)	ed) (Status: patented, pending, abandoned)				
(Applicat	ion No.)	(Day Month Year	Filed)	(Status: patented, pending, abandoned)				
As a named inventor business in the Patent	, I hereby appoint and Trademark Of	t the following register	ed practioners to pr h:	osecute this ag	pplication a	nd to tra	nsact all	
·	All of the	practioners associated	with Customer Nu	mber 001444				
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The undersigned hereby authorizes the U.S. Attorneys or Agents appointed herein to accept and follow instructions from MEIKI CO. LTD. as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. Attorneys or Agents and the undersigned. In the event of a change of the persons from whom instructions may be taken, the U.S. Attorneys or Agents appointed herein will be so notified by the undersigned.

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Page 2 of 2 Pages	,	Atty.	Docket:
Title: DIE FOR MOLDING D	ISC SUBSTRATES		
IS Application filed	Serial No.		
J.S. Application filed	Serial No.		
hereby further declare that all statements made information and belief are believed to be true; and tatements and the like so made are punishable by false statements may jeopardize the validity of the ap	i that these statements were made wine or imprisonment, or both, under 1	ith the knowledge U.S.C. §1001 a	ge that willful lais
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